Document Number: STBV25165A2C Preliminary Datasheet V1.0

GaN 50V, 165W,2.45GHz RF Power Transistor

Description

The STBV25165A2C is a single ended 165 watt capable, GaN HEMT, ideal for ISM applications at 2.45GHz. It can be used in CW, Pulse and any other modulation modes. There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

2 pieces of STBV25165A2C combined could be a cost effective option for 300W power amplifier

Typical RF performance at selected 2.4-2.5GHz applications with device soldered on heatsink

VDD = 50Vdc, Vgs=-4.5V



Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
2400	52.22	166.8	66.9	19.45	53	199.7	71.1
2450	51.64	146.0	68.1	20.09	52.71	186.5	74.2
2500	50.69	117.2	66.8	19.91	52.15	163.9	76.0

CW:

Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
2400	52.39	173.3	66.3	18.51	52.92	195.7	70.4
2450	51.76	150.0	67.5	19.18	52.63	183.4	72.3
2500	50.77	119.3	66.3	19.1	52.12	162.8	74.4

Applications

- 2.45GHz RF Energy
- S band power amplifier

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

Turning the device ON

- 1. Set VGS to the pinch--off (VP) voltage, typically –5 $\mbox{\em V}$
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Table 1. Maximum Ratings

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Rating	Symbol	Value	Unit		
DrainSource Voltage	V _{DSS}	+200	Vdc		
GateSource Voltage	V _{GS}	-8 to +0.5	Vdc		
Operating Voltage	V _{DD}	55	Vdc		
Maximum gate current	Igs	22.5	mA		
Storage Temperature Range	Tstg	-65 to +150	°C		
Case Operating Temperature	T _C	+150	°C		
Operating Junction Temperature	T _J	+225	°C		

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Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Thermal Resistance, Junction to Case by FEA	Rejc	1.5	°C /W	
T _C = 85°C, at Pd=55W		1.5	-C /VV	

Table 3. Electrical Characteristics (TA = 25℃ unless otherwise noted)

DC Characteristics (measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=22.5mA	V _{DSS}		200		V
Gate Threshold Voltage	VDS =10V, ID = 22.5mA	$V_{GS(th)}$	-4	=	-2	V
Gate Quiescent Voltage	VDS =50V, IDS=150mA, Measured in Functional Test	$V_{GS(Q)}$		3.3		V

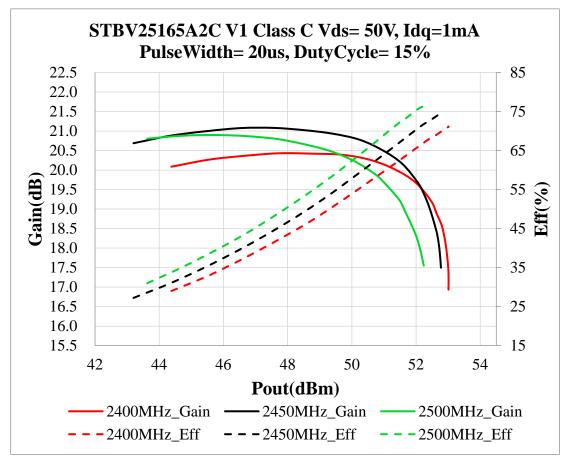
Ruggedness Characteristics

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	2.45GHz, Pout=165W pulse CW					
	All phase,	VSWR		10:1		
	No device damages					

TYPICAL CHARACTERISTICS

Figure 1: Efficiency and power gain as function of Pout

(VDD = 50Vdc, Vgs=-3.4V, Pulse width=20us, duty cycle=10%)



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Figure 2: S11/S21 output from Network analyser

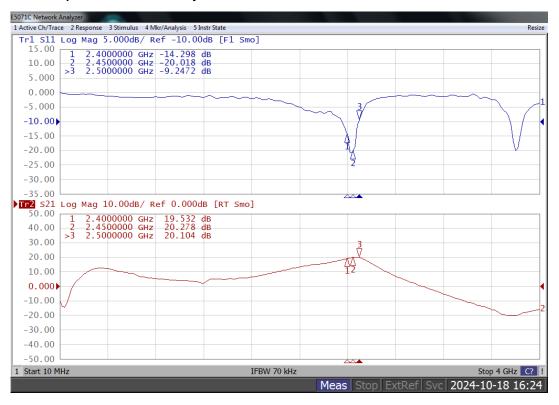
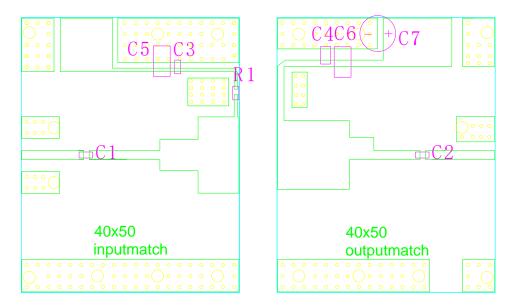


Figure 3: Reference design circuit (RO4350B 20mil, PCB DWG file upon request,)

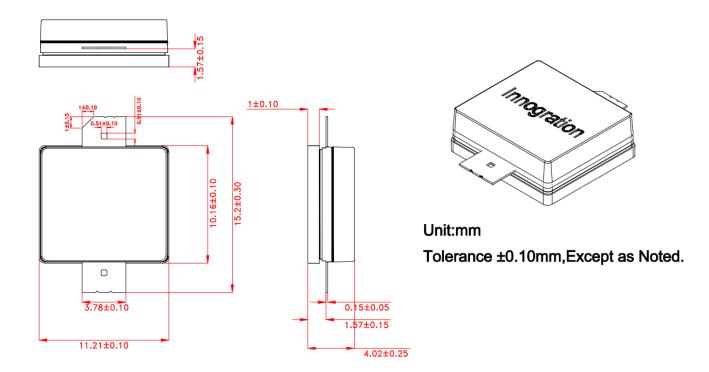


Designator	Comment	Footprint	Quantity
C1, C2, C3, C4	12 pF	0805	4
C5, C6	10 uF/100V	1210	2
C7	470 uF/63V		1
R1	10 Ω	0603	1

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Package Dimensions (Unit:mm)



Revision history

Table 1. Document revision history

Date	Revision	Datasheet Status
2024/10/21	Rev 1.0	Preliminary Datasheet

Application data based on LSM-24-32

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